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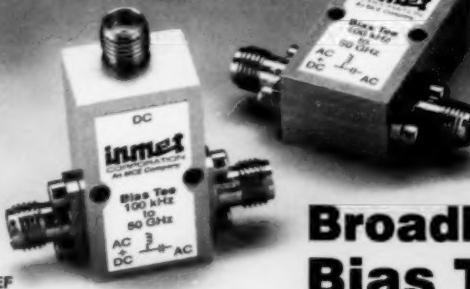
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Inmet's new broadband bias tee uses 2.4mm connectors and operates from 100kHz to 50GHz. Ideal for optical communications applications, the 8810E has less than 3dB of insertion loss at 50GHz and handles 250mA of bias current, with a DC-RF isolation better than 30dB across the frequency band. The 8810 Series will also offer alternative connector types for both the RF and DC connections.



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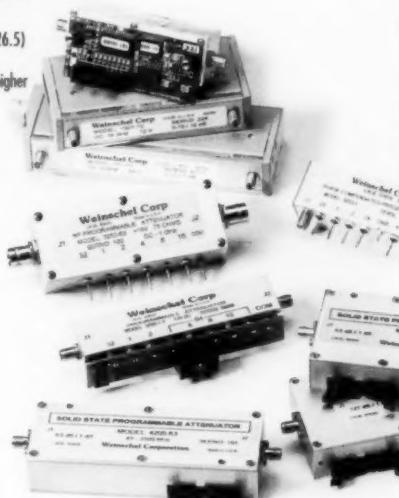
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3200-2	dc-2.0	0.63.75/25	8	+
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3201-2	dc-2.0	120/10	5	+
3201-4	dc-2.0	1.2/1	5	
3203-1	dc-1.5	103/1	8	♦
3204-1	dc-1.5	55/1	8	♦
3205-1	dc-2.0	70/10	5	
3205-2	dc-2.0	55/5	5	
3205-3	dc-2.0	1.5/1	5	
3206-1	dc-2.0	63/1	8	
3209-1	dc-2.0	645.0/1.0	10	
3220-1	dc-2.0	127/1	8	*
3221-1	dc-2.0	31/1	5	*
3221-2	dc-2.0	120/10	5	*
3230-43	dc-1.2	63/1	8	
3230-70	dc-1.2	90/10	8	
3230-63.75	dc-1.2	63.75/25	8	
3230-95.5	dc-1.2	95.5/0.5	8	
3250-63	dc-1.8	63/1	6	*
150-11	dc-18.0	11/1	4	+
150-15	dc-18.0	15/1	4	+
150-47	dc-18.0	62/2	5	+
150-70	dc-18.0	70/10	3	+
150-75	dc-18.0	75/5	4	+
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4216-63	0.8-2.3	63/1	6
4218-63.75	0.8-2.3	0.63.75/25	8
4218-127	0.8-2.3	127/1	8



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5305 Spectrum Drive, Frederick, Maryland 21703-7362  
 800-638-2048 • Tel: 301-846-9222 • Fax: 301-846-9116  
 e-mail: sales@weinschel.com • Web: www.weinschel.com